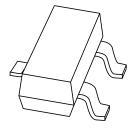
DISCRETE SEMICONDUCTORS

DATA SHEET



BC849; BC850 NPN general purpose transistors

Product data sheet Supersedes data of 1999 Apr 08 2004 Jan 16



NPN general purpose transistors

BC849; BC850

FEATURES

• Low current (max. 100 mA)

• Low voltage (max. 45 V).

APPLICATIONS

• General purpose switching and amplification.

DESCRIPTION

NPN transistor in a SOT23 plastic package. PNP complements: BC859 and BC860.

MARKING

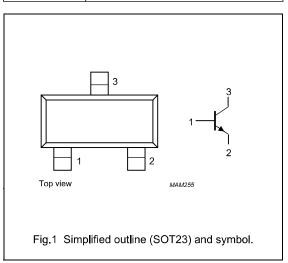
TYPE NUMBER	MARKING CODE ⁽¹⁾	TYPE NUMBER	MARKING CODE ⁽¹⁾	
BC849B	2B*	BC850B	2F*	
BC849C	2C*	BC850C	2G*	

Note

* = p : Made in Hong Kong.
 * = t : Made in Malaysia.
 * = W : Made in China.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



ORDERING INFORMATION

TYPE	PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION
BC849B	-	plastic surface mounted package; 3 leads	SOT23
BC849C			
BC850B			
BC850C			

NPN general purpose transistors

BC849; BC850

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BC849		-	30	v
	BC850		-	50	v
V _{CEO}	collector-emitter voltage	open base			
	BC849		-	30	v
	BC850		-	45	v
V _{EBO}	emitter-base voltage	open collector	_	5	V
Ic	collector current (DC)		_	100	mA
I _{CM}	peak collector current		_	200	mA
I _{BM}	peak base current		_	200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	250	mW
T _{stg}	storage temperature		– 65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		- 65	+150	°C

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT	
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	500	K/W	

Note

1. Transistor mounted on an FR4 printed-circuit board.

^{1.} Transistor mounted on an FR4 printed-circuit board.

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CHARACTERISTICS

 T_j = 25 °C unless otherwise specified.

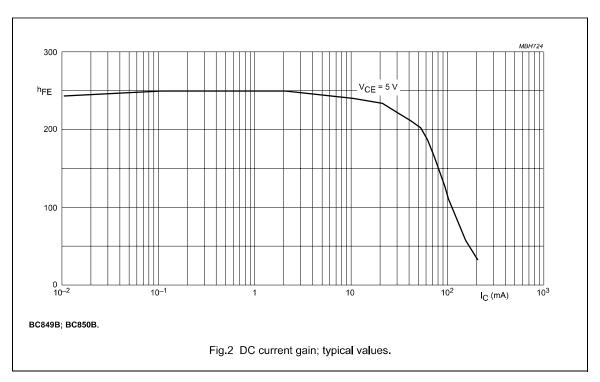
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	I _E = 0; V _{CB} = 30 V	-	-	15	nA
		I _E = 0; V _{CB} = 30 V; T _j = 150 °C	-	-	5	μΑ
I _{EBO}	emitter cut-off current	I _C = 0; V _{EB} = 5 V	_	_	100	nA
h _{FE}	DC current gain	I _C = 10 μA; V _{CE} = 5 V;				
	BC849B; BC850B	see Figs 2 and 3	-	240	-	
	BC849C; BC850C		-	450	-	
	DC current gain	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V};$				
	BC849B; BC850B	see Figs 2 and 3	200	290	450	
	BC849C; BC850C		420	520	800	
V _{CEsat}	collector-emitter saturation	I _C = 10 mA; I _B = 0.5 mA	-	90	250	mV
vol	voltage	I _C = 100 mA; I _B = 5 mA	_	200	600	mV
V_{BEsat}	base-emitter saturation voltage	I_C = 10 mA; I_B = 0.5 mA; note 1	_	700	_	mV
		I_C = 100 mA; I_B = 5 mA; note 1	_	900	_	mV
V_{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}; \text{ note } 2$	580	660	700	mV
		I_C = 10 mA; V_{CE} = 5 V; note 2	_	_	770	mV
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$	-	2.5	_	pF
C _e	emitter capacitance	$I_C = I_c = 0$; $V_{EB} = 500 \text{ mV}$; $f = 1 \text{ MHz}$	_	11	_	pF
f _T	transition frequency	I_C = 10 mA; V_{CE} = 5 V; f = 100 MHz	100	_	_	MHz
F	noise figure	I_C = 200 μA; V_{CE} = 5 V; R_S = 2 kΩ; f = 10 Hz to 15.7 kHz	-	-	4	dB
		I_C = 200 μA; V_{CE} = 5 V; R_S = 2 kΩ; f = 1 kHz; B = 200 Hz	-	_	4	dB

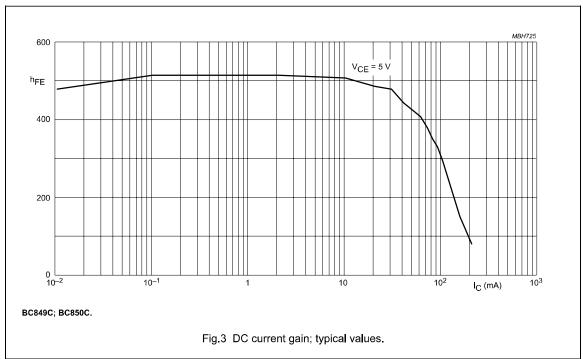
Notes

- 1. V_{BEsat} decreases by about 1.7 mV/K with increasing temperature.
- 2. V_{BE} decreases by about 2 mV/K with increasing temperature.

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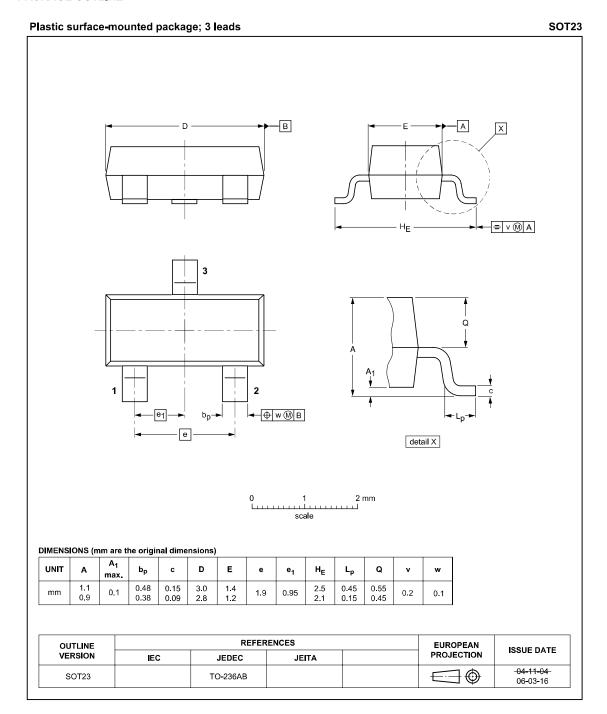




NPN general purpose transistors

BC849; BC850

PACKAGE OUTLINE



NPN general purpose transistors

BC849; BC850

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- The product status of device(s) described in this document may have changed since this document was published
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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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